

2303081418 Additional Assembly, Test and Ship Site for BGM220P and BGX220P Modules

PCN Issue Date: Mar 08, 2023 Effective Date: Jun 14, 2023

PCN Type: Assembly; Test

Description of Change

Silicon Labs is pleased to announce the successful qualification of Ryder Shenzhen as an additional assembly, test and ship site for BGM220P module production. Ryder Shenzhen is certified to ISO9001.

As of the effective date of this PCN, Silicon Labs will start assembling, testing and shipping BGM220P and BGX220P modules from Ryder.

Ryder Shenzhen Address Ryder Electronics (Shenzhen) Ltd. Costal 1 139 Da Bao Road Bao An, District 33 518133 SHENZHEN CHINA

Reason for Change

The additional assembly and test location will provide additional capacity for supply assurance.

Impact on Form, Fit, Function, Quality, Reliability

No change to Form, Fit, Function, Quality or Reliability.

Product Identification

This notification includes both standard and customer-specific part numbers. An asterisk * represents a number or letter (one or more) in a customer-specific part number.

Existing Part #
BGM220PC22HNA2
BGM220PC22HNA2R
BGM220PC22WGA2
BGM220PC22WGA2R
BM22P2WGP*A2
BM22P2WGP*A2R
MGM220PC22HNA2
MGM220PC22HNA2R
BGX220P22HNA21
BGX220P22HNA21R

Last Date of Unchanged Product: Jun 14, 2023

Qualification Samples

Samples available upon request

Customer Response

Lack of acknowledgment of the PCN within 30 days constitutes acceptance of the change, Ref. JEDEC-J-STD-046.

To request further data or inquire about this notification, please contact your Silicon Labs sales representative. A list of Silicon Labs sales representatives is available at http://www.silabs.com.

Customers may approve early PCN acceptance by emailing approval, along with PCN # to PCNEarlyAcceptance@silabs.com

User Registration

Register today to create your account on Silabs.com. Your personalized profile allows you to receive technical document updates, new product announcements, "how-to" and design documents, product change notices (PCN) and other valuable content available only to registered users. http://www.silabs.com/profile

Qualification Data

Please refer to qualification report below.

BGM220P, MGM220P, BGX220P Qualification Report

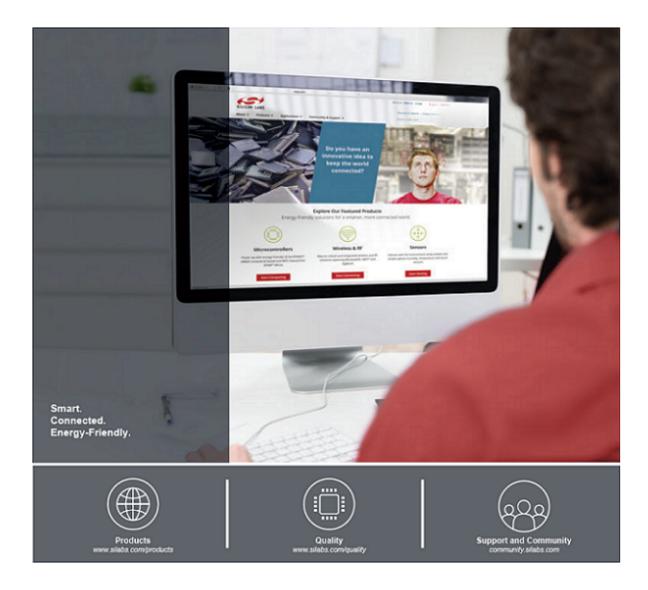


BGM220P, MGM220P, BGX220P DELTA China assembly except as noted									
Test Name	Test Condition	Qualification	Lot ID or Start	Fail/Pass or End	Notes	Summary	Status		
Test Group A – A	ccelerated Environment Str	ress Tests							
Preconditioning	JESD22-A113 MSL3: 260°C 30°C / 60%RH / 192 Hr	1 lot, N=>10	Q045504 Q049864	0/12 0/12	2	2 lots 0/24	Pass		
Temp Cycle	JESD22-A104 Cond G: -40°C to 125°C 850 cycles	1 lot, N=>10	Q045506 Q049873	0/12 0/11	1 1, 2	2 lots 0/23	Pass		
Test Group C – P	ackage Assembly Integrity	Tests							
Mechanical Shock	JESD22-B110, Cond. B (1500g)	1 lot, N=>10	Q045509 Q049861	0/10 0/10	2	2 lots 0/20	Pass		
Mechanical Vibration	JESD22-B103, Cond. 1 (20-2000Hz)	1 lot, N=>10	Q045510 Qo49862	0/10 0/10	2	2 lots 0/20	Pass		
Cleanliness Assessment	IPC-TM-650 2.3.28B	1 lot, N=>10	Q045511 Q049860	0/10 0/10	2	2 lots 0/20	Pass		
	lectrical Verification								
ESD-CDM	JS-002	1 lot, N=>3	Q045561 Q049866		2	500V 500V	Class 2a Class 2a		

Notes:

- 1. Parts are Pre-conditioned at MSL3/260°C
- 2. RYDER China assembly

This report applies to the following part numbers:						
BGM220P						
MGM220P						
BGX220P						



Disclaimer

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